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N-Channel SuperFET[®] II MOSFET

800 V, 17 A, 0.29 Ω

Features

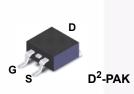
- R_{DS(on)} = 0.259 Ω (Typ.)
- Ultra Low Gate Charge (Typ. Q_g = 58 nC)
- Low E_{oss} (Typ. 5.4 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 240 pF)
- 100% Avalanche Tested
- RoHS Compliant

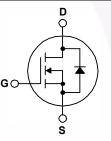
Applications

- AC DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			FCB290N80	Unit	
V _{DSS}	Drain to Source Voltage			800	V	
V _{GSS}		- DC	- DC		V	
	Gate to Source Voltage	- AC	±30	v		
	Drain Current	- Continuous (T _C = 25 ^o C)		17	Δ	
ID		- Continuous (T _C = 100 ^o C)		10.8	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	42	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			882	mJ	
I _{AR}	Avalanche Current (Note 1)			3.4	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)			2.12	mJ	
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)			20		
P _D	Devues Dissiscation	(T _C = 25 ^o C)	$(T_{\rm C} = 25^{\rm o}{\rm C})$		W	
	Power Dissipation	- Derate Above 25°C	- Derate Above 25°C			
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		Seconds	300	°C	

Thermal Characteristics

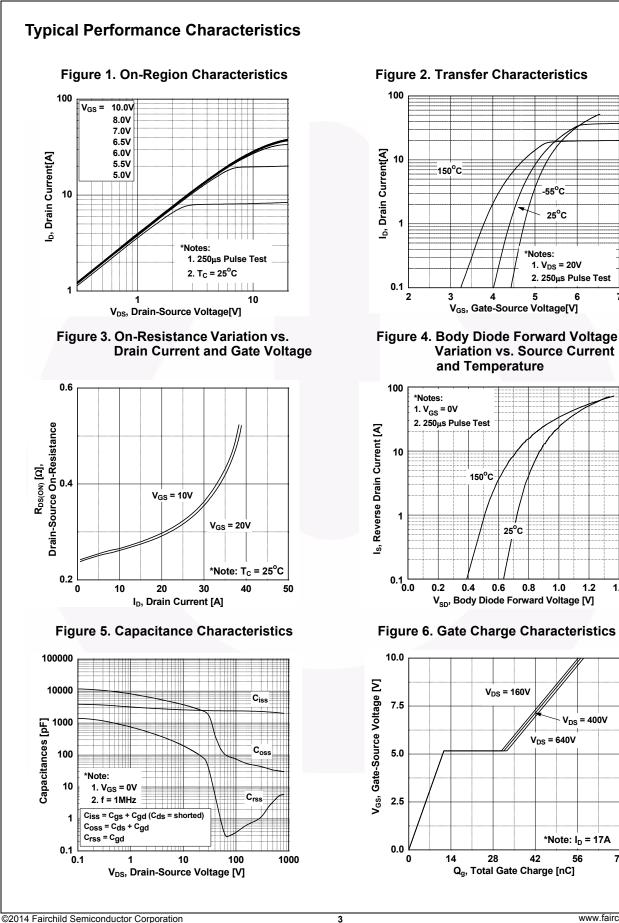
Symbol	Parameter	FCB290N80	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.59	
C	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient (1 in ² Pad of 2-oz Copper), Max.	40	

FCB290N80
N-Channel S
SuperFET [®] II MC
OSFET

180 FCB290N80 Characteristics T _C = 25°C Parameter eristics	D ² -PAK	Tape and Reel erwise noted. Test Conditions	330 m		24 mm	80	00 units
Parameter	unless oth				I	·	
Parameter							
eristics				Min.	Typ.	Max.	Uni
eristics							1
					1		
Drain to Source Breakdown Voltage		V_{GS} = 0 V, I_{D} = 1 mA, T_{J} = 25°C		800	-	-	V
Breakdown Voltage Temperature Coefficient		$I_D = 1 \text{ mA}$, Referenced to 25° C		-	0.85	-	V/º(
Zero Gate Voltage Drain Current	V _{DS} =	$V_{DS} = 800 V, V_{GS} = 0 V$ $V_{DS} = 640 V, V_{GS} = 0 V, T_C = 125^{\circ}C$		-	-	25	
Zero Gale Vollage Drain Gurrent	V _{DS} =			-	-	250	μA
Gate to Body Leakage Current	V _{GS} =	±20 V, V _{DS} = 0 V		-	-	±10	μA
eristics							
Gate Threshold Voltage	Vcs =	V_{DS} $l_{D} = 1.7 \text{ mA}$		25	-	4 5	V
							Ω
				-		-	S
	- 03						
					0.440	000-	-
		100 V. V _{CS} = 0 V.	_				pF
			_		-		pF
							pF
•							pF
			V	-			pF
			_	-		75	nC
	V _{GS} =	10 V	a	-		-	nC
•			(Note 4)	-		-	nC
Equivalent Series Resistance	f = 1 N	1Hz		-	0.75	-	Ω
						1	
,			_	-		-	ns
			_	-			ns
·	v _{GS} –	10 v, rg = 4.7 sz	_		-	-	ns
Turn-Off Fall Time			(Note 4)		2.6	15	ns
e Diode Characteristics							
Maximum Continuous Drain to Sour	ce Diode Fo	orward Current		-	-	17	Α
Maximum Pulsed Drain to Source D	iode Forwa	rd Current		-	-	42	Α
Drain to Source Diode Forward Volta	age V _{GS} =	= 0 V, I _{SD} = 17 A		-	-	1.2	V
Reverse Recovery Time	V _{GS} =	V _{GS} = 0 V, I _{SD} = 17 A,		-	511	-	ns
Reverse Recovery Charge	dl _F /dt	t = 100 A/μs		-	12		μC
	Coefficient Zero Gate Voltage Drain Current Gate to Body Leakage Current eristics Gate Threshold Voltage Static Drain to Source On Resistanc Forward Transconductance haracteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Output Capacitance Effective Output Capacitance Output Capacitance Effective Output Capacitance Total Gate Charge at 10V Gate to Source Gate Charge Gate to Drain "Miller" Charge Equivalent Series Resistance Characteristics Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Ce Diode Characteristics Maximum Continuous Drain to Source D Drain to Source Diode Forward Volta Reverse Recovery Time	CoefficientIDIDIDZero Gate Voltage Drain Current $V_{DS} =$ Gate to Body Leakage Current $V_{GS} =$ Gate Threshold Voltage $V_{GS} =$ Static Drain to Source On Resistance $V_{GS} =$ Forward Transconductance $V_{DS} =$ Input Capacitance $V_{DS} =$ Output Capacitance $V_{DS} =$ Reverse Transfer Capacitance $V_{DS} =$ Output Capacitance $V_{DS} =$ Gate to Source Gate Charge $V_{DS} =$ Gate to Drain "Miller" Charge $V_{GS} =$ Equivalent Series Resistance $f = 1 N$ Characteristics $V_{DS} =$ Turn-On Delay Time $V_{DD} =$ Turn-Off Delay Time $V_{GS} =$ Turn-Off Fall Time $V_{GS} =$ Cable Characteristics $V_{GS} =$ Maximum Continuous Drain to Source Diode Forward $V_{GS} =$ Reverse Recovery Time $V_{GS} =$	CoefficientIDI mA, Referenced to 2stZero Gate Voltage Drain Current $V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$ Gate to Body Leakage Current $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ eristicsStatic Drain to Source On Resistance $V_{GS} = 10 \text{ V}, I_D = 8.5 \text{ A}$ Forward Transconductance $V_{DS} = 20 \text{ V}, I_D = 8.5 \text{ A}$ hput Capacitance $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ Output Capacitance $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ Output Capacitance $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ Output Capacitance $V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ Output Capacitance $V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ Gate to Source Gate Charge $V_{DS} = 640 \text{ V}, I_D = 17 \text{ A}, V_{GS} = 10 \text{ V}$ Gate to Drain "Miller" Charge $V_{DD} = 400 \text{ V}, I_D = 17 \text{ A}, V_{GS} = 10 \text{ V}, R_g = 4.7 \Omega$ Turn-On Delay Time $V_{DD} = 400 \text{ V}, I_D = 17 \text{ A}, V_{GS} = 10 \text{ V}, R_g = 4.7 \Omega$ Turn-Off Delay Time $V_{GS} = 10 \text{ V}, R_g = 4.7 \Omega$ Turn-Off Fall Time $V_{GS} = 0 \text{ V}, I_{SD} = 17 \text{ A}, V_{GS} = 0 \text{ V}, I_{SD} = 17 \text{ A}, Reverse Recovery TimeTrain to Source Diode Forward CurrentDarin to Source Diode Forward CurrentDrain to Source Diode Forward VoltageV_{GS} = 0 \text{ V}, I_{SD} = 17 \text{ A}, Reverse Recovery Time$	CoefficientID1 mA, Referenced to 25°CZero Gate Voltage Drain Current $V_{DS} = 800 V, V_{GS} = 0 V$ Qate to Body Leakage Current $V_{GS} = 440 V, V_{GS} = 0 V, V_{DS} = 0 V$ Gate to Body Leakage Current $V_{GS} = \pm 20 V, V_{DS} = 0 V$ eristicsGate Threshold Voltage $V_{GS} = \pm 20 V, V_{DS} = 0 V$ Gate Threshold Voltage $V_{GS} = 10 V, I_D = 8.5 A$ Forward Transconductance $V_{DS} = 20 V, I_D = 8.5 A$ Porward Transconductance $V_{DS} = 100 V, V_{GS} = 0 V, f = 1 MHz$ Reverse Transfer Capacitance $V_{DS} = 480 V, V_{GS} = 0 V, f = 1 MHz$ Output Capacitance $V_{DS} = 480 V, V_{GS} = 0 V, f = 1 MHz$ Effective Output Capacitance $V_{DS} = 640 V, I_D = 17 A, V_{GS} = 0 V$ Total Gate Charge at 10V $V_{DS} = 640 V, I_D = 17 A, V_{GS} = 10 V$ Gate to Drain "Miller" Charge $V_{DD} = 400 V, I_D = 17 A, V_{GS} = 10 V, V_{GS} = 0 V, V_{SS} = 10 V, V_{GS} = 0 V, V_{SS} = 10 V, V_{GS} = 0 V, V_{SS} = 10 V, V_{SS} = 0 V, V_$	CoefficientID 	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

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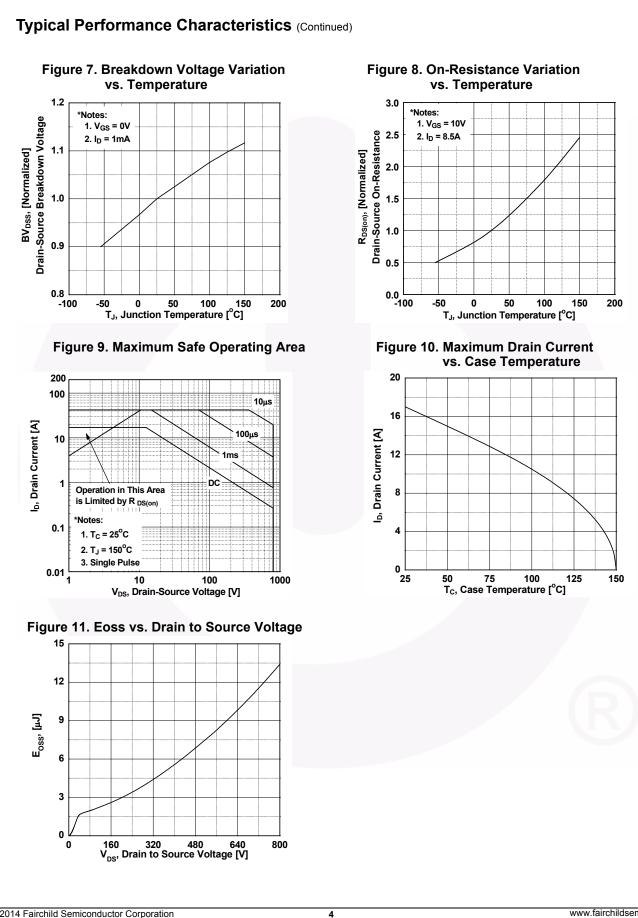
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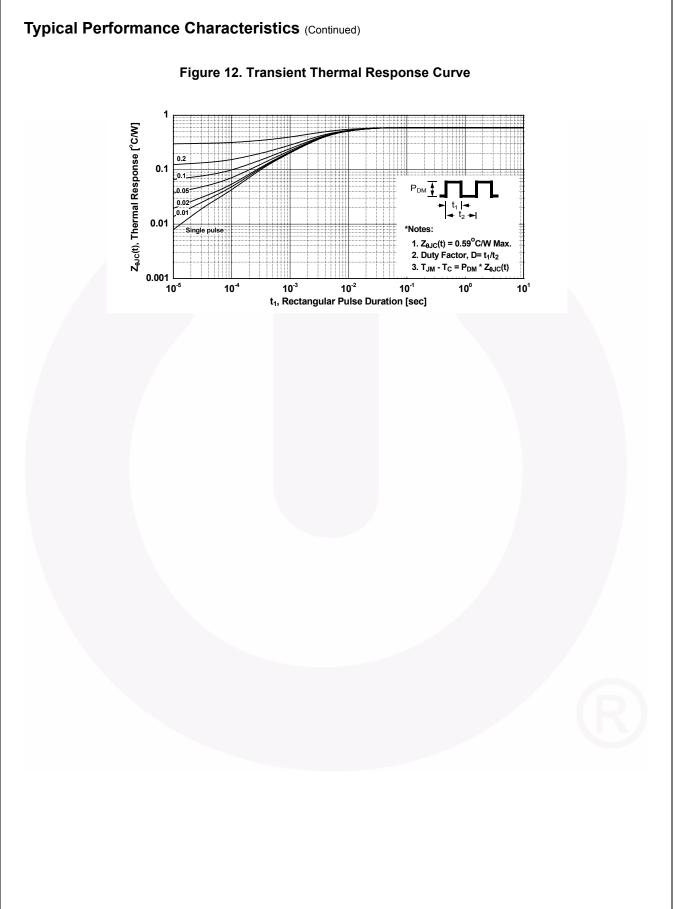


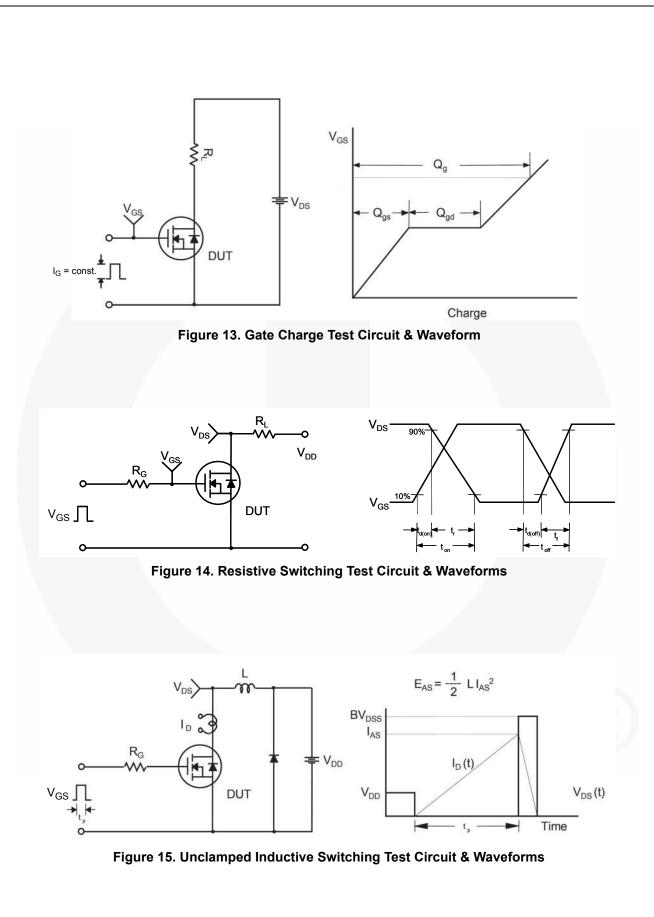
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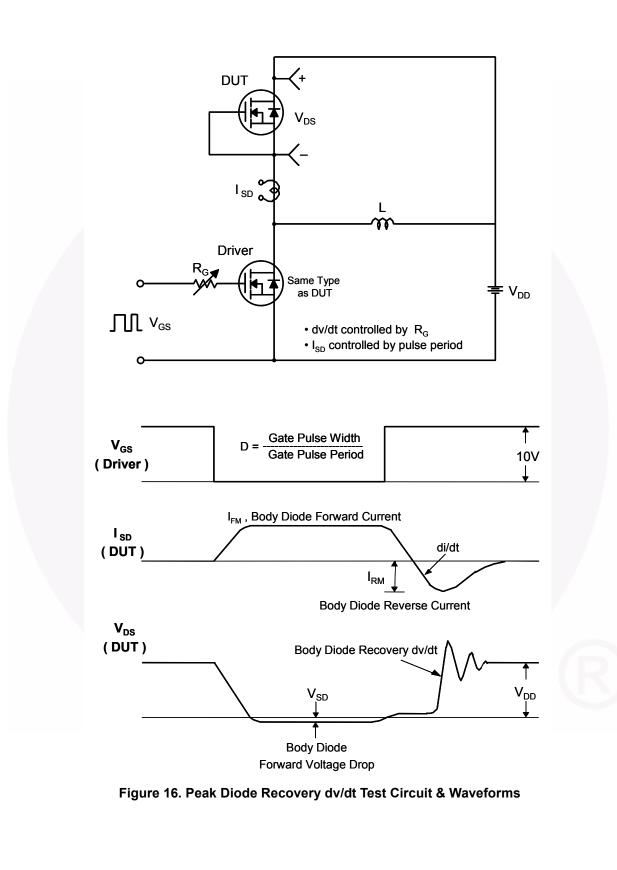


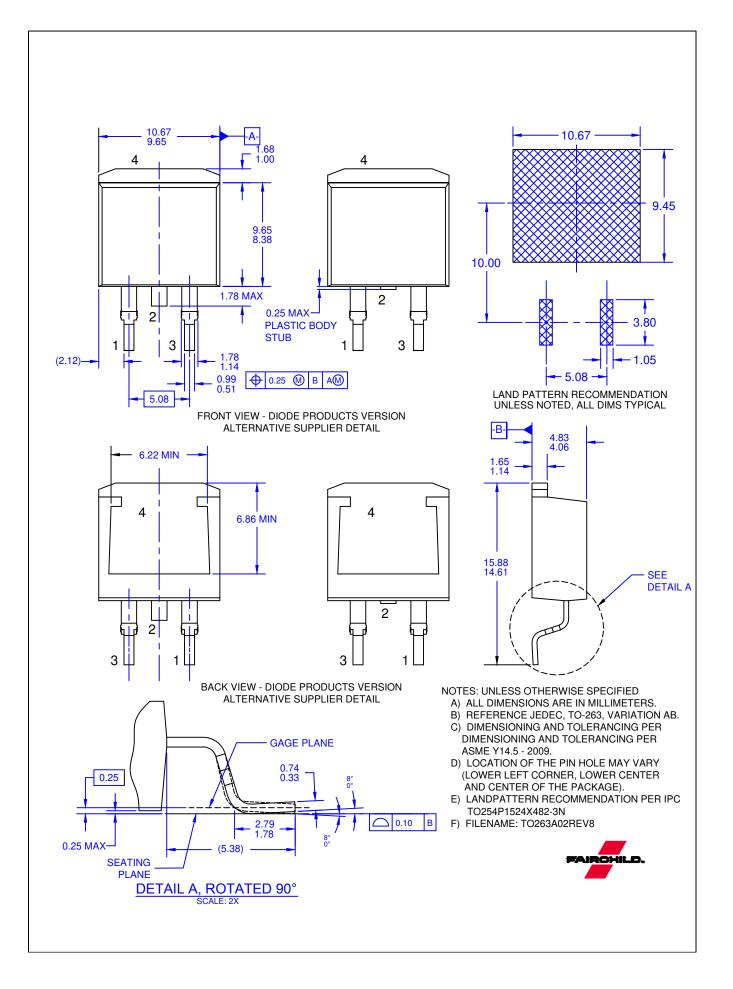




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